



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	V _{(BR)DSS}	R _{DS(ON)}	I _D T _A = +25°C
Q1	20V	$35m\Omega$ @ V_{GS} = $4.5V$	4.5A
Qi	Q1 20V	$56m\Omega$ @ V_{GS} = 1.8 V	3.5A
02 201/	$74mΩ @ V_{GS} = -4.5V$	-3.1A	
Q2	-20V	$168m\Omega$ @ V_{GS} = -1.8 V	-2.0A

Description

This MOSFET has been designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Motor Control
- Power Management Functions

TSOT26

Top View

- DC-DC Converters
- Backlighting

Mechanical Data

Low On-Resistance Low Input Capacitance Fast Switching Speed Low Input/Output Leakage Fast Switching Speed

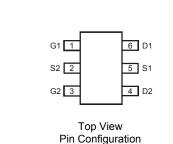
Case: TSOT26

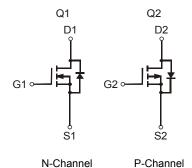
Features

Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0

Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2) Halogen and Antimony Free. "Green" Device (Note 3) Qualified to AEC-Q101 standards for High Reliability

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Matte Tin annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections Indicator: See diagram
- Weight: 0.013 grams (approximate)





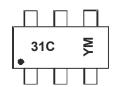
Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
DMC2038LVT-7	Standard	TSOT26	3000/Tape & Reel
DMC2038LVTQ-7	Automotive	TSOT26	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html

Marking Information



31C = Product Type Marking Code YM = Date Code Marking Y = Year (ex: X = 2010) M = Month (ex: 9 = September)

Date Code Key

Year	2010	0	2011		2012	20	13	2014		2015	2	2016
Code	X		Υ		Z	/	4	В		С		D
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings N-CHANNEL – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units	
Drain-Source Voltage			V_{DSS}	20	V	
Gate-Source Voltage			V _{GSS}	±12	V	
		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	3.7 3.0	А	
Continuous Drain Current (Note 5) V _{GS} = 4.5V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	l _D	4.1 3.2	Α	
Continuous Prain Current (Note 6) // - 4 5/	Steady State	T _A = +25°C T _A = +70°C	I _D	4.5 3.6	Α	
Continuous Drain Current (Note 6) V _{GS} = 4.5V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	l _D	5.2 4.2	Α	
Maximum Continuous Body Diode Forward Current (Note 6)			Is	1.5	Α	
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	25	A	

Maximum Ratings P-CHANNEL – Q2 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage			V _{DSS}	-20	V
Gate-Source Voltage			V _{GSS}	±12	V
		T _A = +25°C T _A = +70°C	I _D	-2.6 -2.1	А
Continuous Drain Current (Note 5) V _{GS} = -4.5V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-2.9 -2.4	А
Continuous Dunin Courset (Note C) V - 45V	Steady State	T _A = +25°C T _A = +70°C	I _D	-3.1 -2.5	А
Continuous Drain Current (Note 6) V _{GS} = -4.5V	t<10s	T _A = +25°C T _A = +70°C	I _D	-3.8 -3.0	А
Maximum Continuous Body Diode Forward Current (Note 6)			Is	-1.5	Α
Pulsed Drain Current (10µs pulse, duty cycle = 1%))		I _{DM}	-17	А

Thermal Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Total Dower Dissination (Note 5)	T _A = +25°C	0	0.8	W
Total Power Dissipation (Note 5)	T _A = +70°C	P_{D}	0.5	VV
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	0	168	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{ heta JA}$	120	C/VV
Total Power Dissipation (Note 6)	T _A = +25°C	D	1.1	W
Total Fower Dissipation (Note 0)	T _A = +70°C	P_{D}	0.7	VV
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	ם	114	
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	72	°C/W
Thermal Resistance, Junction to Case (Note 6)		$R_{ heta JC}$	39	
Operating and Storage Temperature Range		$T_{J,}T_{STG}$	-55 to +150	°C

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

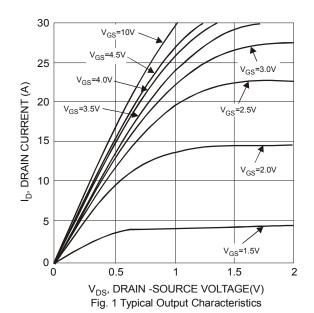


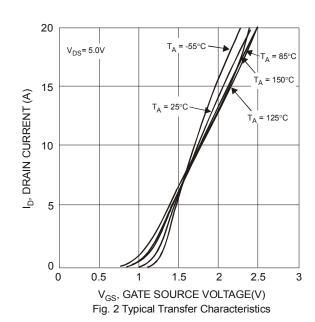
Electrical Characteristics N-CHANNEL - Q1 (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)			31			
Drain-Source Breakdown Voltage	BV _{DSS}	20	_	_	V	V _{GS} = 0V, I _D = 250μA
Zero Gate Voltage Drain Current @T _c = +25°C	I _{DSS}	_	_	1.0	μΑ	V _{DS} =16V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	V _{GS} = ±12V, V _{DS} = 0V
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	0.4	_	1.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
		_	27	35		$V_{GS} = 4.5V, I_D = 4.0A$
Static Drain-Source On-Resistance	R _{DS (ON)}	_	33	43	mΩ	V _{GS} = 2.5V, I _D = 2.5A
		_	43	56		V _{GS} = 1.8V, I _D = 1.5A
Forward Transfer Admittance	Y _{fs}	_	9	_	S	V _{DS} = 5V, I _D = 3.4A
Diode Forward Voltage	V_{SD}	0.4	_	1.1	V	V _{GS} = 0V, I _S = 1A
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	_	400	530	pF	101/1/
Output Capacitance	Coss	_	70	90	pF	$V_{DS} = 10V, V_{GS} = 0V,$ -f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	65	100	pF	-1 - 1.0WHZ
Gate Resistance	R_g	_	1.9	_	Ω	V_{DS} = 0V, V_{GS} = 0V, f = 1MHz
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	5.7	_	nC	
Total Gate Charge (V _{GS} = 10V)	Qg	_	12	17	nC	
Gate-Source Charge	Q _{gs}	_	0.7	_	nC	$V_{DS} = 15V, I_D = 5.8A$
Gate-Drain Charge	Q_{gd}	_	1.4	_	nC	
Turn-On Delay Time	t _{D(on)}	_	5	10	ns	
Turn-On Rise Time	t _r	_	8	16	ns	V _{DS} = 10V, V _{GS} = 4.5V,
Turn-Off Delay Time	t _{D(off)}	_	25	40	ns	$R_G = 6\Omega$, $I_{DS} = 1A$,
Turn-Off Fall Time	t _f	_	8	16	ns	

Notes: 7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.

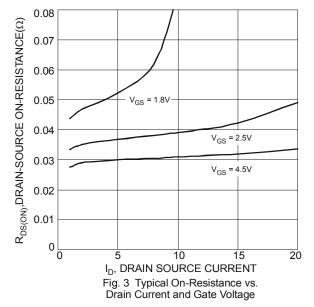


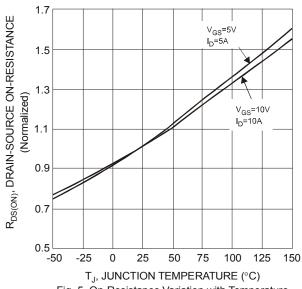


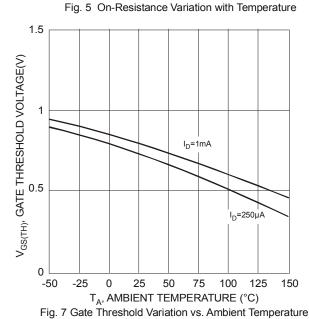
T_A = 150°C

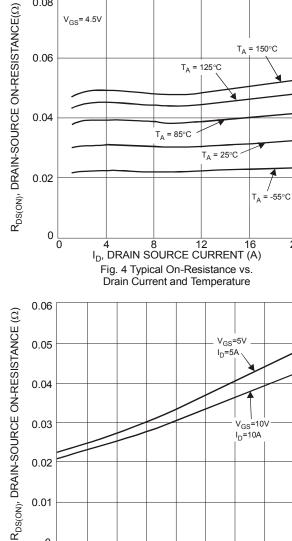
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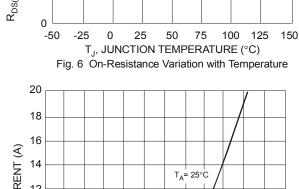


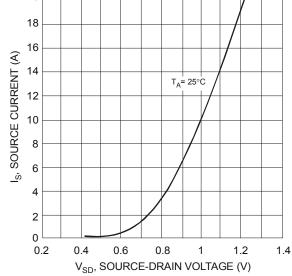
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0.06

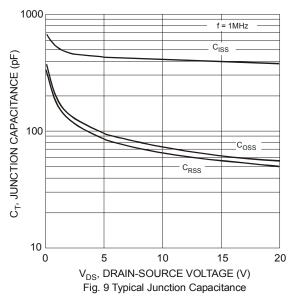
0.01

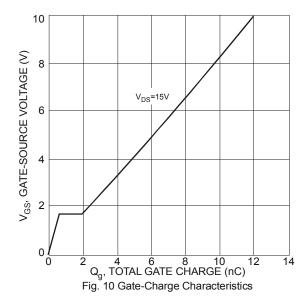
V_{GS}= 4.5V

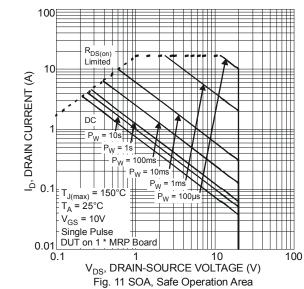


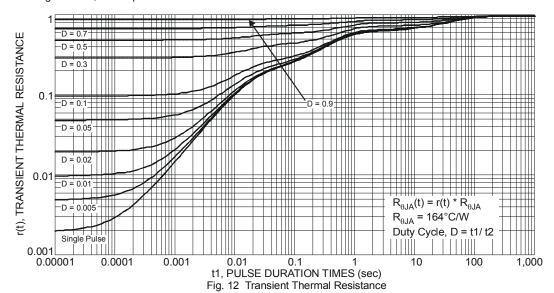












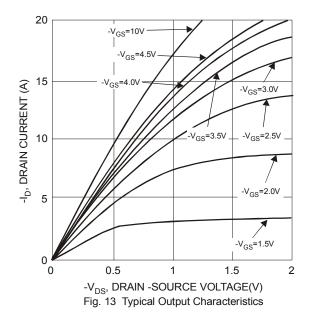


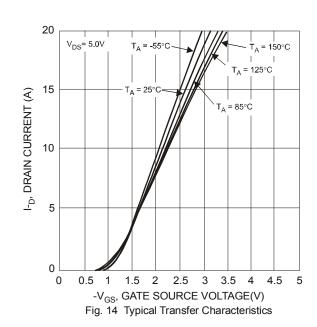
Electrical Characteristics P-CHANNEL - Q2 (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	-20		_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current @T _c = +25°C	I _{DSS}	_	_	-1.0	μΑ	V _{DS} = -16V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	-0.4	_	-1.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
		_	57	74		$V_{GS} = -4.5V$, $I_D = -3.0A$
Static Drain-Source On-Resistance	R _{DS (ON)}	_	76	110	mΩ	$V_{GS} = -2.5V$, $I_D = -1.5A$
		_	102	168		$V_{GS} = -1.8V, I_D = -1.0A$
Forward Transfer Admittance	Y _{fs}	_	10	_	S	$V_{DS} = -5V, I_D = -3.0A$
Diode Forward Voltage	V_{SD}	_	-0.8	-1.0	V	$V_{GS} = 0V, I_{S} = -0.6A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	_	530	705	pF	101/11/
Output Capacitance	Coss	_	70	95	pF	$V_{DS} = -10V, V_{GS} = 0V,$ -f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	60	90	pF	1 - 1.5///12
Gate Resistance	R_g	_	72	-	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	7	10	nC	
Total Gate Charge (V _{GS} = -10V)	Qg	_	14	_	nC	V _{DS} = -15V,I _D = -6A
Gate-Source Charge	Qgs	_	0.95	_	nC	V _{DS} = -15V,I _D = -6A
Gate-Drain Charge	Q _{gd}	_	1.2	_	nC	
Turn-On Delay Time	t _{D(on)}	_	11	20	nS	
Turn-On Rise Time	t _r	_	12	22	nS	V_{DS} = -10V, V_{GS} = -4.5V,
Turn-Off Delay Time	t _{D(off)}	_	21	34	nS	$R_G = 6\Omega$, $I_S = -1A$,
Turn-Off Fall Time	t _f	_	13	23	nS	

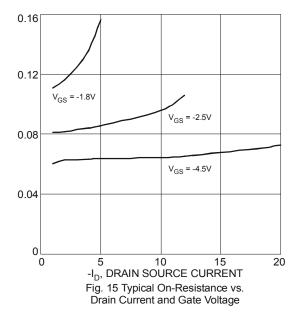
Notes:

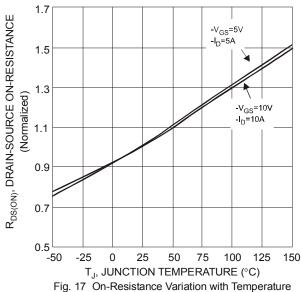
- 7. Short duration pulse test used to minimize self-heating effec 8. Guaranteed by design. Not subject to product testing.

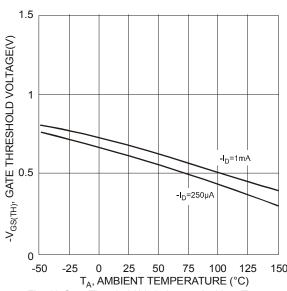




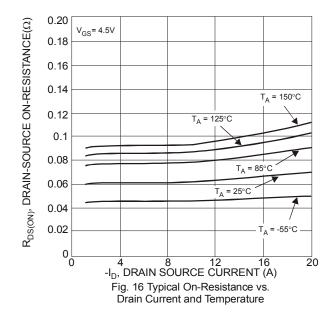


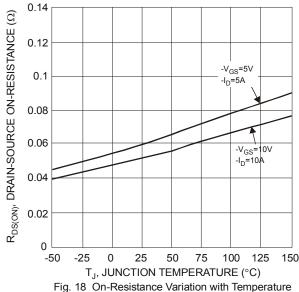






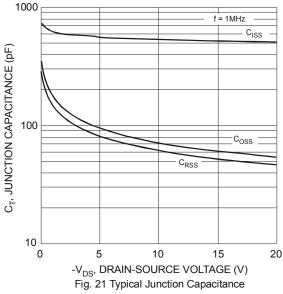


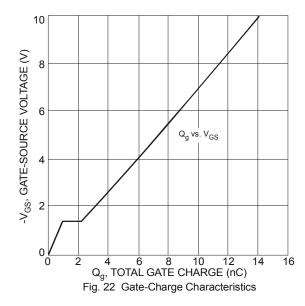


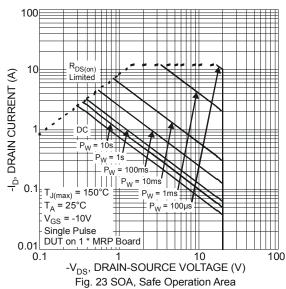


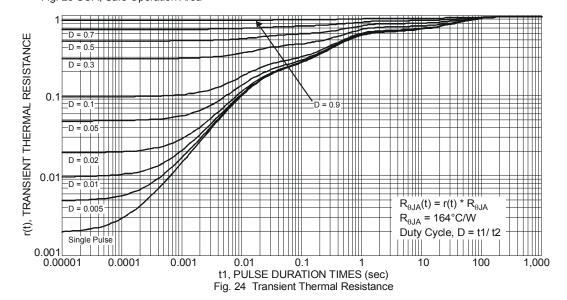
20 18 16 -I_S, SOURCE CURRENT (A) T_A= 25°C 14 12 10 8 6 2 0 0.2 0.4 0.6 8.0 1 1.2 1.4 1.6 -V_{SD}, SOURCE-DRAIN VOLTAGE (V) Fig. 20 Diode Forward Voltage vs. Current







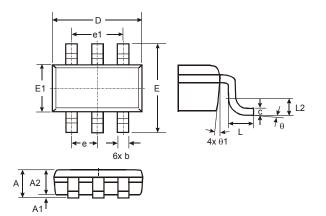






Package Outline Dimensions

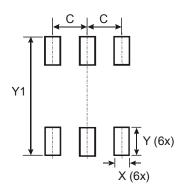
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



TSOT26							
Dim	Min	Max	Тур				
Α	1	1.00	1				
A1	0.01	0.10	_				
A2	0.84	0.90	-				
D	2.85	2.95	2.90				
E	2.70	2.90	2.80				
E1	1.55	1.65	1.60				
b	0.30	0.45	-				
С	0.12	0.20	_				
е	BSC	BSC	0.95				
e1	BSC	BSC	1.90				
L	0.30	0.50					
L2	BSC	BSC	0.25				
θ	0°	8°	4°				
θ1	4°	12°	_				
All D	imens	ions ir	n mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199



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